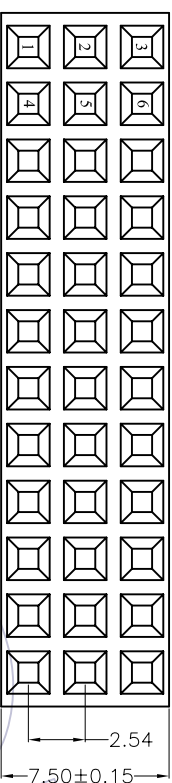


HSP

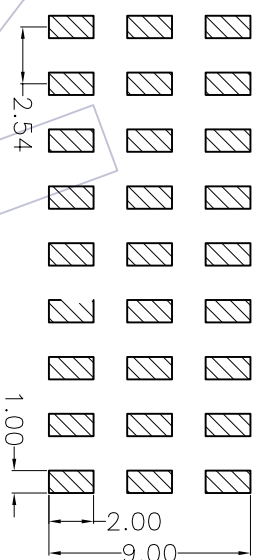
NOTES:

Current Rating:3.0AMP
 Withstand Voltage:500V AC/DC
 Contact Resistance:20mΩ Max
 Insulation Resistance:1000MΩMin
 Operation Temperature:-40°C to +105°C

Contact Material:Phosphor Bronze or Brass
 Contact plating:Au or Sn over Ni
 Insulator Material:PA6T+30%G.F UL94V-0



Recommended P.C.B Layout(TOP Side)
 (PCB BOARD TOLERANCE±0.05)



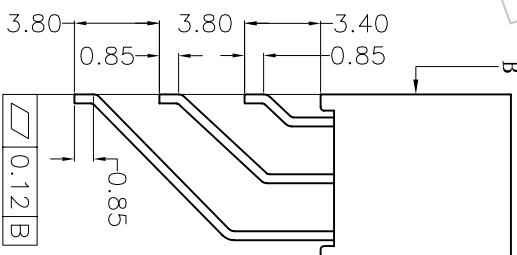
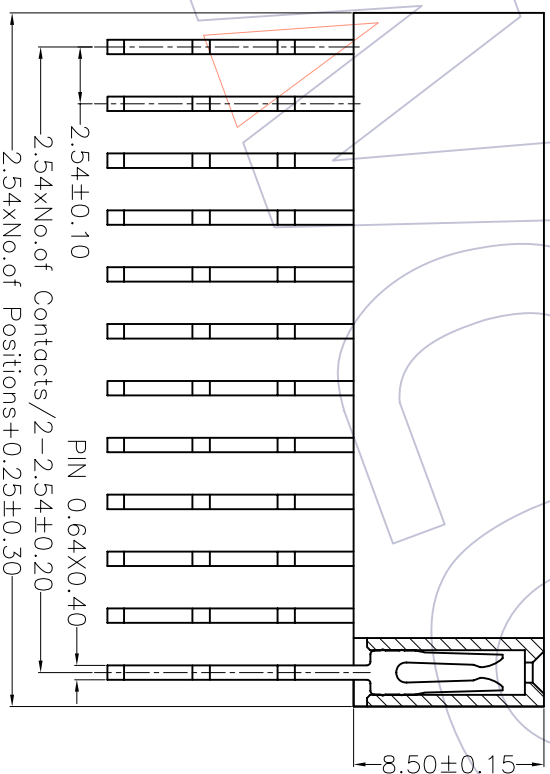
Ordering Information

2185 - 3 XX Z XX C Y N T 1

No of Pins per ROW:02-40PIN

Contact Plating:
 G0=Gold Flash
 G1=3µ"Gold
 G2=5µ"Gold
 G3=10µ"Gold
 G4=15µ"Gold
 G5=30µ"Gold
 S0=Gold Flash/Tin
 S1=3µ"Gold/Tin
 S2=5µ"Gold/Tin
 S3=10µ"Gold/Tin
 S4=15µ"Gold/Tin
 S5=30µ"Gold/Tin
 SN=Tin

Packaging:
 T=Tube
 P=Tape&Reel



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	PART NO.	TITLE:
A0	09/02/07	NEW			X.X ±0.40	DESIGN	09.02.07	3:1	2185-3XXZXXCYNT1	PH2.54 THREE ROW 90° SMT H=8.5
					X.XX ±0.25	CHECK		A4		
					X.XXX ±0.15	APPROVE		1/1		
					Angle ± 3'			Customer NO.		

WCON 维峰五金电子有限公司
 WAVE HARDWARE ELECTRONICS CO.,LTD